Docket No.: 50232-074 **PATENT**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277

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Kazushi SANO, et al. : Confirmation Number: 6277

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Serial No.: Divisional of

Appln. Serial No. 09/741,023 : Group Art Unit: Not yet assigned

Filed: August 05, 2003 : Examiner: Not yet assigned

For: COPPER PARTICLE CLUSTERS AND POWDER CONTAINING THE SAME

SUITABLE AS CONDUCTIVE FILLER OF CONDUCTIVE PASTE

TRANSMITTAL OF FORMAL DRAWINGS

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Submitted herewith are six (06) sheets of formal drawings as corrected and filed in parent Application Serial No. 09/741,024.

Respectfully submitted,

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Date: August 5, 2003